

# TWLF51

Embedded 1.8" SBC

User's Manual

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## Trademarks

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## FCC and DOC Statement on Class A

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and the receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio TV technician for help.

## Notice:

1. The changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.
2. Shielded interface cables must be used in order to comply with the emission limits.

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## About this Manual

This manual can be retrieved from the website.

The manual is subject to change and update without notice, and may be based on editions that do not resemble your actual products. Please visit our website or contact our sales representatives for the latest editions.

## Warranty

1. Warranty does not cover damages or failures that arises from misuse of the product, inability to use the product, unauthorized replacement or alteration of components and product specifications.
2. The warranty is void if the product has been subjected to physical abuse, improper installation, modification, accidents or unauthorized repair of the product.
3. Unless otherwise instructed in this user's manual, the user may not, under any circumstances, attempt to perform service, adjustments or repairs on the product, whether in or out of warranty. It must be returned to the purchase point, factory or authorized service agency for all such work.
4. We will not be liable for any indirect, special, incidental or consequential damages to the product that has been modified or altered.

## About this Package

The package contains the following items. If any of these items are missing or damaged, please contact your dealer or sales representative for assistance.

- 1 TWLF51 Board
- 1 Thermal Solution

Note: The items are subject to change in the developing stage. The product and accessories in the package may not come similar to the information listed above. This may differ in accordance with the sales region or models in which it was sold. For more information about the standard package in your region, please contact your dealer or sales representative.

## Static Electricity Precautions

It is quite easy to inadvertently damage your PC, system board, components or devices even before installing them in your system unit. Static electrical discharge can damage computer components without causing any signs of physical damage. You must take extra care in handling them to ensure against electrostatic build-up.

1. To prevent electrostatic build-up, leave the system board in its anti-static bag until you are ready to install it.
2. Wear an antistatic wrist strap.
3. Do all preparation work on a static-free surface.
4. Hold the device only by its edges. Be careful not to touch any of the components, contacts or connections.
5. Avoid touching the pins or contacts on all modules and connectors. Hold modules or connectors by their ends.



### Important:

Electrostatic discharge (ESD) can damage your processor, disk drive and other components. Perform the upgrade instruction procedures described at an ESD workstation only. If such a station is not available, you can provide some ESD protection by wearing an antistatic wrist strap and attaching it to a metal part of the system chassis. If a wrist strap is unavailable, establish and maintain contact with the system chassis throughout any procedures requiring ESD protection.

## Safety Precautions

- Use the correct DC / AC input voltage range.
- Unplug the power cord before removing the system chassis cover for installation or servicing. After installation or servicing, cover the system chassis before plugging in the power cord.
- There is danger of explosion if battery incorrectly replaced.
- Replace only with the same or equivalent specifications of batteries recommend by the manufacturer.
- Dispose of used batteries according to local ordinance.
- Keep this system away from humid environments.
- Make sure the system is placed or mounted correctly and stably to prevent the chance of dropping or falling may cause damage.
- The openings on the system shall not be blocked and shall be kept in distance from

other objects to make sure of proper air ventilation to protect the system from over-heating.

- Dress the cables, especially the power cord, so they will not be stepped on, in contact with high temperature surfaces, or cause any tripping hazards.
- Do not place anything on top of the power cord. Use a power cord that has been approved for use with the system and is compliant with the voltage and current ranges required by the system's electrical specifications.
- If the system is to be unused or stored for a long time, disconnect it from the power source to avoid damage by transient overvoltage.
- If one of the following occurs, consult a service personnel:
  - The power cord or plug is damaged.
  - Liquid has penetrated the system.
  - The system has been exposed to moisture.
  - The system is not working properly.
  - The system is physically damaged.
- The unit uses a three-wire ground cable which is equipped with a third pin to ground the unit and prevent electric shock. Do not defeat the purpose of this pin. If your outlet does not support this kind of plug, contact your electrician to replace the outlet.
- Disconnect the system from the electricity outlet before cleaning. Use a damp cloth for cleaning the surface. Do not use liquid or spray detergents for cleaning.
- Before connecting, make sure that the power supply voltage is correct. The device is connected to a power outlet which should be grounded connection.



The system may burn fingers while running.

Wait for 30 minutes to handle electronic parts after power off.

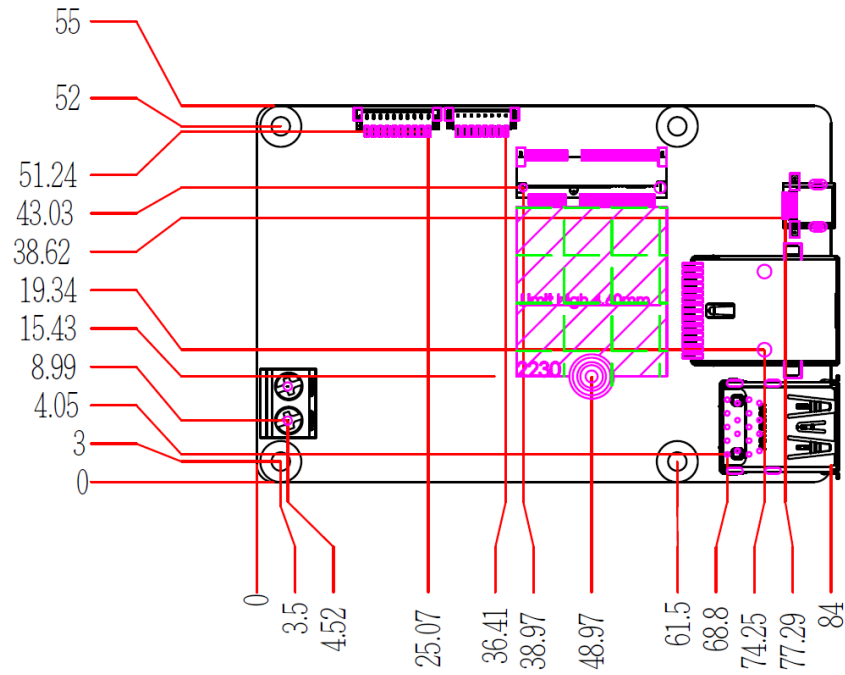
## Chapter 1 - Introduction

### ► Specifications

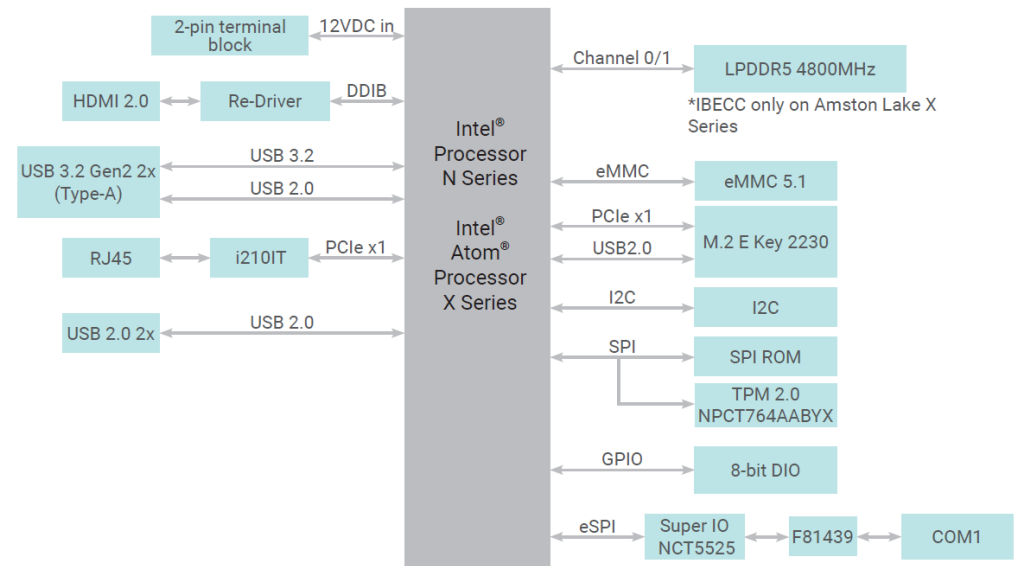
<b>SYSTEM</b>	Processor	Intel® Processor N series (Code Name: Twin Lake) Intel® Core™ 3 Processor N355, 8 Cores, 1.8~3.9 GHz, 15W Intel® Processor N150, 4 Cores, 1.0~3.6 GHz, 6W Intel Atom® Processor X Series (Code Name: Amston Lake) Intel Atom® Processor x7835RE, 8 Cores, 1.3~3.6 GHz, 12 W Intel Atom® Processor x7433RE, 4 Cores, 1.5~3.4 GHz, 9 W Intel Atom® Processor x7211RE, 2 Cores, 1.0~3.2 GHz, 6 W
	Memory	LPDDR5 memory down up to 8GB Single-channel LPDDR5 4800MHz
	BIOS	AMI SPI 256Mbit
<b>GRAPHICS</b>	Controller	Intel® UHD Graphics
	Feature	OpenGL 4.6, Direct X 12.1, OpenCL 3.0 HW Decode: HEVC, VP9, AV1, AVC HW Encode: HEVC, VP9, AVC
	Display	1 x Micro HDMI HDMI 2.0: resolution up to 4096x2160 @ 60Hz
<b>EXPANSION</b>	Interface	1 x M.2 E key 2230 (PCIe Gen3 x1/USB 2.0)
<b>ETHERNET</b>	Controller	1 x Intel® i210IT(10/100/1000Mbps)
<b>REAR I/O</b>	Ethernet	1 x GbE (RJ-45)
	USB	2 x USB 3.2 Gen2, 10Gbps (Type-A)
	Display	1 x Micro HDMI (HDMI 2.0)
<b>INTERNAL I/O</b>	DIO	1 x 8-bit DIO
	I2C/SMBus	I2C/SMBus (Opt.)
<b>STORAGE</b>	eMMC	Default 64GB, up to 128GB
<b>WATCHDOG TIMER</b>	Output & Interval	Software Reset, Programmable via Software from 1 to 655,535 Seconds
<b>SECURITY</b>	TPM	dTPM 2.0
	Type	Single 12V +/-5% DC
	Connector	2-pin Terminal Block
<b>POWER</b>	Consumption	Typical: x7835RE (w/Cooler), 12V @ 0.39A (4.68W) Max: x7835RE (w/Cooler), 12V @ 3.33A (39.96W)
	RTC Battery	CR2032 Coin Cell

<b>OS SUPPORT</b>	Microsoft	Windows 11 IoT Enterprise
	Linux	Linux
<b>MECHANISM</b>	Dimensions	1.8" SBC Form Factor - 84mm (3.31") x 55mm (2.17")
	Height	PCB: 1.6mm Top Side: 16.35mm Bottom Side: 4mm
<b>ENVIRONMENT</b>	Temperature	Operating: -5 to 65°C / -20 to 70°C Storage: -40 to 85°C
	Humidity	Operating: 5 to 90% RH Storage: 5 to 90% RH
	MTBF	Model: TWLF51-ET-86X78 MTBF (hrs): 693,447 hrs @ 25°C; 510,973 hrs @ 45°C; 372,643 hrs @ 60°C; 291,272 hrs @70°C Calculation model: Telcordia Issue 4 Environment: GB, GC – Ground Benign, Controlled
<b>STANDARDS AND CERTIFICATIONS</b>	Certifications	CE, FCC, RoHS, UKCA

► Dimensions



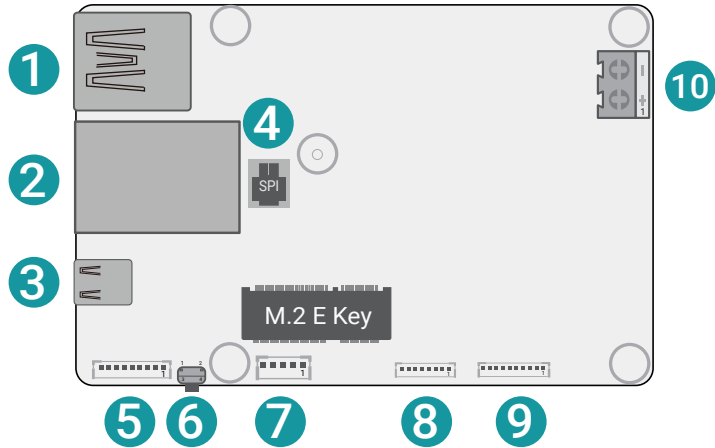
► Block Diagram



## Chapter 2 - Hardware Installations

### ► Overview

#### Top View



- 1 2 x USB 3.2 Gen2

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- 2 1 x GbE (RJ-45)

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- 3 1 x Micro HDMI (HDMI 2.0)

---

- 4 SPI

---

- 5 COM1

---

- 6 Reset Button

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- 7 I2C

---

- 8 USB2.0

---

- 9 DIO

---

- 10 12V DC JACK

---

- 11 CPU Fan

---

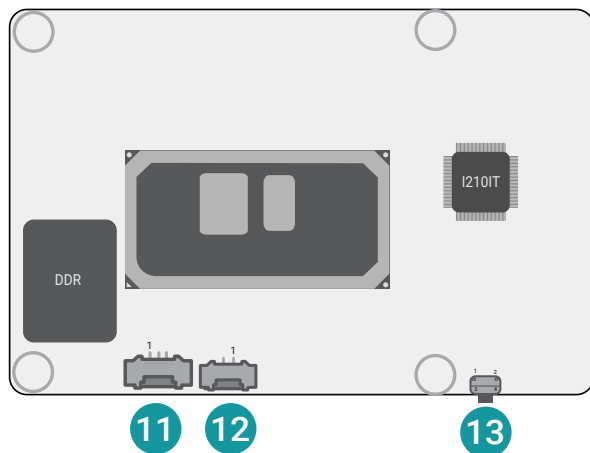
- 12 RTC Battery

---

- 13 Power Button

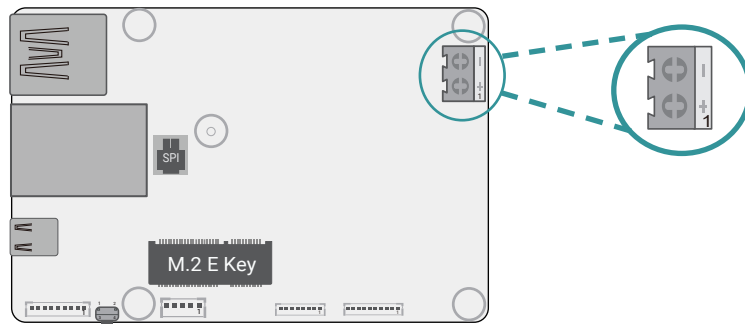
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#### Bottom View



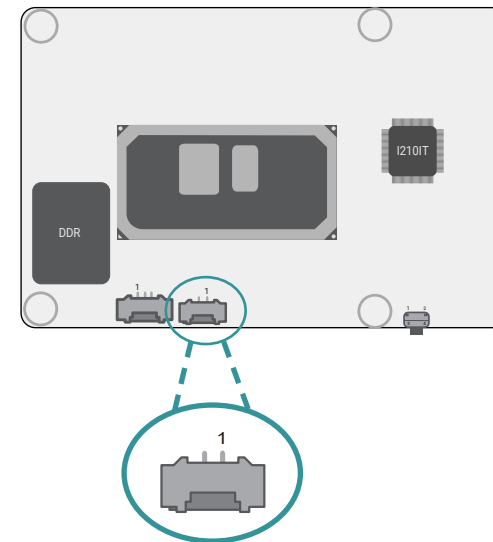
► **Pin Assignment**

12V Power Connector (CN3)



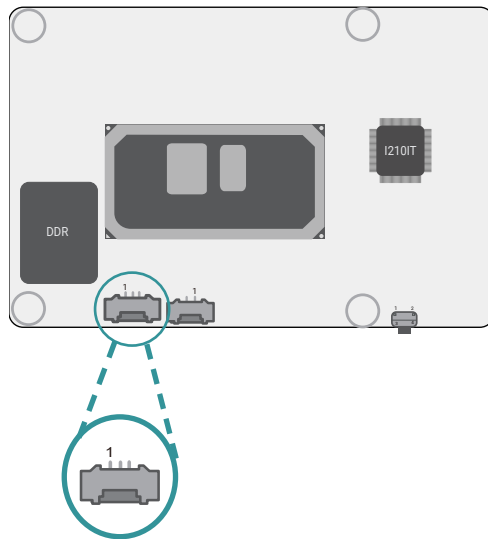
Pin	Assignment
1	DC-IN
2	GND

RTC Battery (J7)



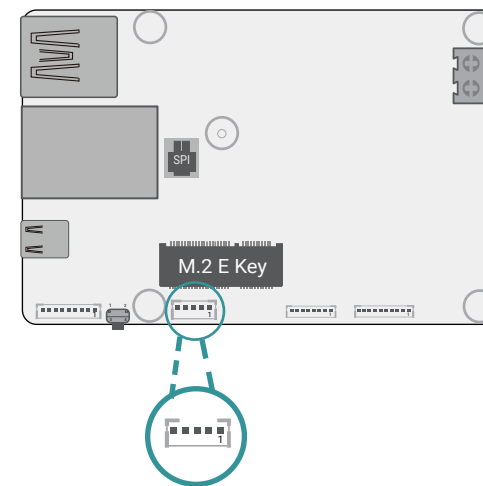
Pin	Assignment
1	GND
2	RTC Signal

CPU Fan (J4)



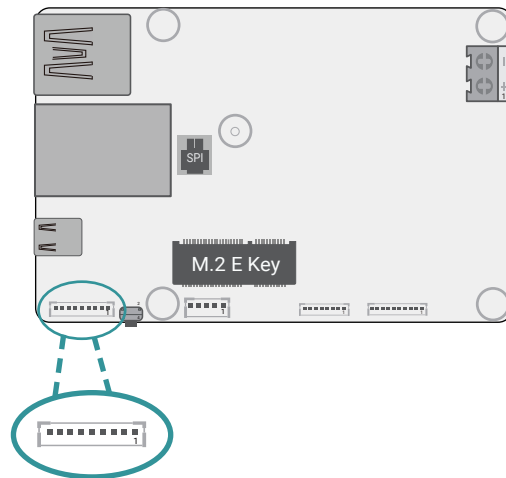
Pin	Assignment
1	N.C.
2	5V
3	GND

I2C (J6)



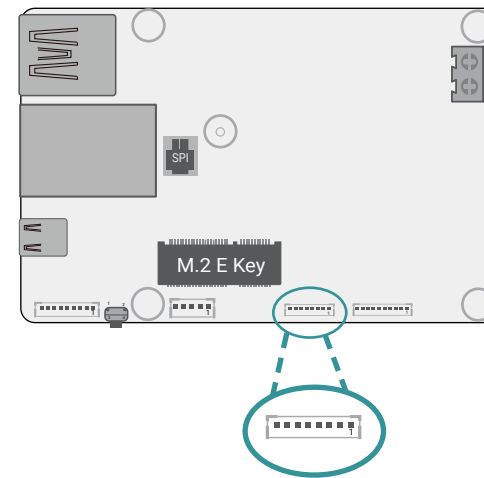
Pin	Assignment
1	3VSB
2	GND
3	I2C0_CLK
4	I2C0_SDA
5	I2C0_INT

COM1 (TSJ1)



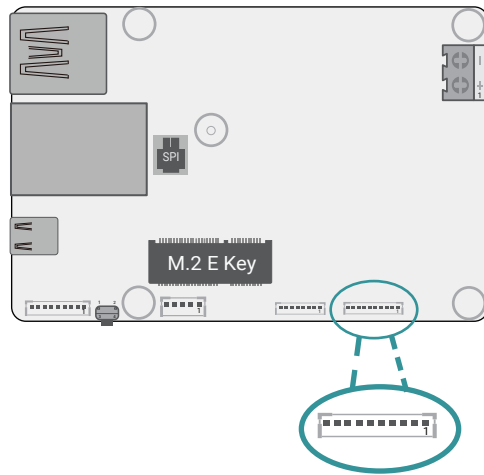
Pin	Assignment	Pin	Assignment
1	MDCD1#	2	MSIN1
3	MSOUT1	4	MDTR1#
5	GND	6	MDSR1#
7	MRTS1#	8	MCTS1#
9	MRI1#		

USB2.0 (J1)



Pin	Assignment	Pin	Assignment
1	USB2_PWR34	2	USB2_1_C_N
3	USB2_1_C_P	4	GND
5	USB2_PWR34	6	USB2_2_C_N
7	USB2_2_C_P	8	GND

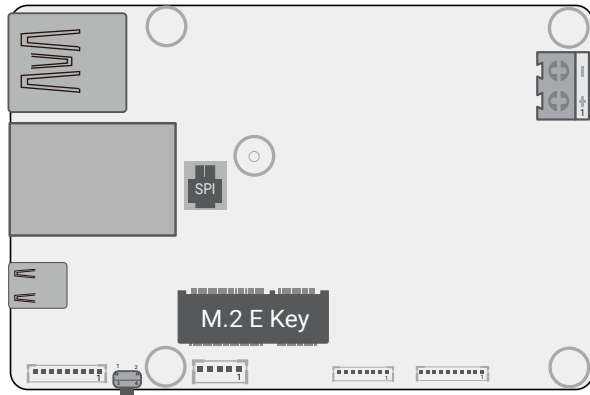
DIO (J5)



Pin	Assignment
1	D_IOA7_C
2	D_IOA6_C
3	D_IOA5_C
4	D_IOA4_C
5	D_IOA3_C
6	D_IOA2_C
7	D_IOA1_C
8	D_IOA0_C
9	5VSB
10	GND

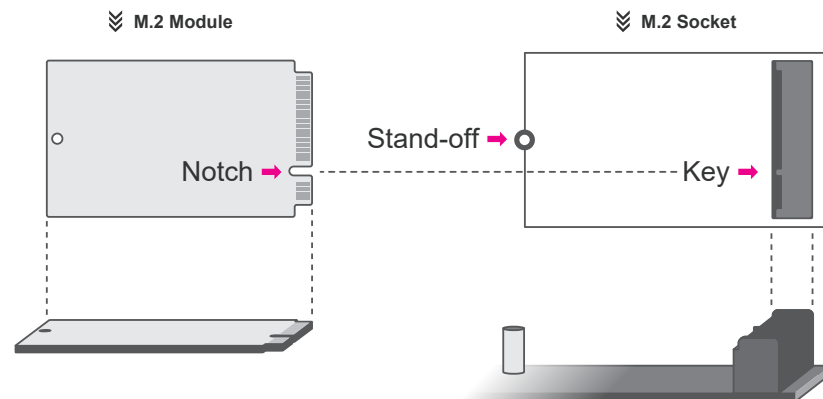
► **Expansion Slots**

Installing the M.2 Module

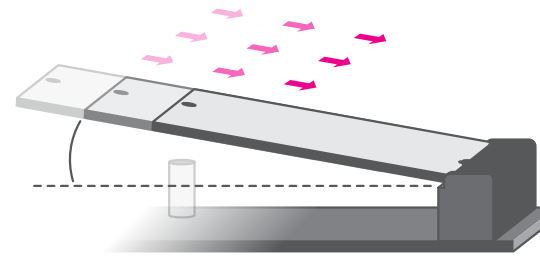


Before installing the M.2 module into the M.2 socket, please make sure that the following safety cautions are well-attended.

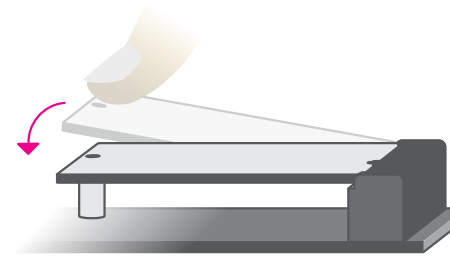
1. Make sure the PC and all other peripheral devices connected to it has been powered down.
2. Disconnect all power cords and cables.
3. Locate the M.2 socket on the system board
4. Make sure the notch on card is aligned to the key on the socket.
5. Make sure the standoff screw is removed from the standoff.



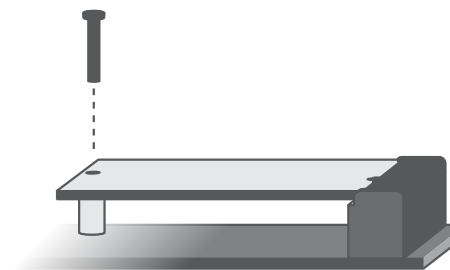
Please follow the steps below to install the card into the socket.



**Step 1:**  
 Insert the card into the socket at an angle while making sure the notch and key are perfectly aligned.



**Step 2:**  
 Press the end of the card far from the socket down until against the stand-off.



**Step 3:**  
 Screw tight the card onto the stand-off with a screw driver and a stand-off screw until the gap between the card and the stand-off closes up. The card should be lying parallel to the board when it's correctly mounted.

► **Installing the Heat Spreader**

**Thermal Interface Material (TIM) Application**

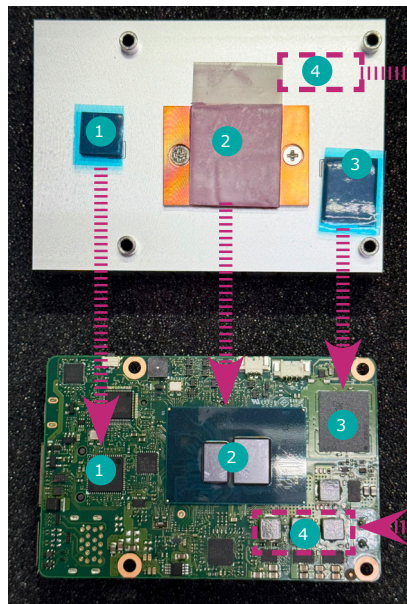
Before installing the heat spreader, apply a thin layer of thermal paste to the top of the CPU. If your heat spreader comes with pre-applied thermal paste (protected by a film), simply peel off the protective strip; do not apply additional paste. The paste will disperse evenly once the heat spreader is secured.

**Installation & Alignment**

Note that the 4 standoffs and screws are supplied separately and are not pre-installed on the heat spreader. Before fastening, ensure the CPU is properly aligned with the heat spreader's copper block, and verify that the 4 mounting holes on the board match the standoffs.

**Securing the Heat Spreader**

To ensure even pressure, partially tighten two screws at opposite corners first, then proceed with the remaining two. Finally, fully tighten all four screws in a cross-pattern.



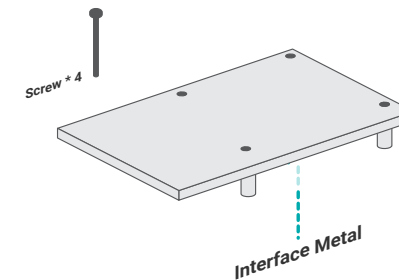
- 1 LAN Chip, PAD\_1: XR-HL 9.8x9.8x4.0t
- 2 CPU, PAD\_2: PG80B 21.5x24x0.5t
- 3 DDR, PAD\_3: XR-HL 15.2x12.6x4.0t
- 4 CHOKE, PAD\_4: 22 × 7 × 0.8t ( $K \approx 2 \text{ W/m}\cdot\text{K}$ )

**\* Thermal Enhancement Recommendation:**  
 To ensure optimal performance in high-temperature environments, it is highly recommended to apply a thermal pad between the heat-generating components and the heatsink to enhance heat dissipation.

**Step-by-Step Installation Guide**

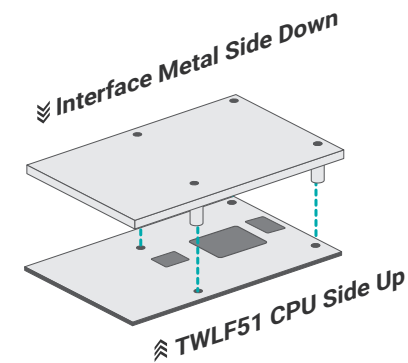
**Step 1:**

A heat spreader is included in the package. Place the module onto the stand-offs and ensure the mounting holes are properly aligned.



**Step 2:**

The heat spreader is designed to be mounted onto the module as illustrated below. Please make sure the contacting sides of the heat spreader and the module are correct – the CPU side of the module shall be facing the interface metal side and legs of the heat spreader. Rotate horizontally so the interface metal sits right on top of the CPU. Remove any plastic cover on the interface metal and apply thermal paste/adhesive if it is required.



**Important:**

- Do not use excessive force or place direct pressure on the board. It affects the board's performance and may damage the motherboard.
- The CPU must be kept cool by using a heat spreader, otherwise the CPU will over heat damaging both the CPU and system board.

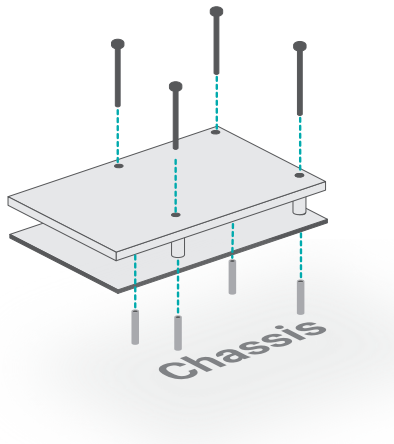
**Step 3:**

Orient the module and heat spreader assembly so that the I/O faces the desired direction, then place it into the designated area within the chassis. Align the mounting holes of the assembly with those on the chassis.

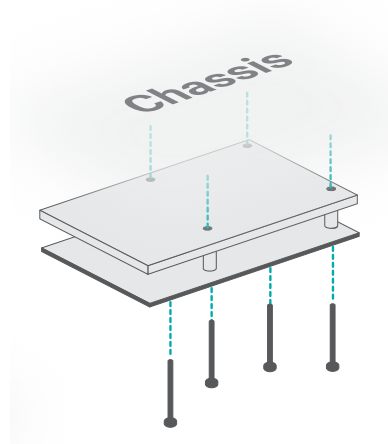
The assembly can be mounted in two configurations—(1) module-side to the chassis, or (2) heat spreader-side to the chassis, as illustrated below. The choice depends on the chassis design regarding internal spacing, thermal requirements, and I/O layout.

Insert the included screws into the mounting holes and tighten them with a screwdriver until the assembly is securely fastened to the chassis.

■ **Module side to chassis**



■ **Heat spreader side to chassis**



## Chapter 3 - BIOS Settings

### ► Overview

The BIOS is a program that takes care of the basic level of communication between the CPU and peripherals. It contains codes for various advanced features found in this system board. The BIOS allows you to configure the system and save the configuration in a battery-backed CMOS so that the data retains even when the power is off. In general, the information stored in the CMOS RAM of the EEPROM will stay unchanged unless a configuration change has been made such as a hard drive replaced or a device added.

It is possible that the CMOS battery will fail causing CMOS data loss. If this happens, you need to install a new CMOS battery and reconfigure the BIOS settings.



#### Note:

The BIOS is constantly updated to improve the performance of the system board; therefore the BIOS screens in this chapter may not appear the same as the actual one. These screens are for reference purpose only.

#### Default Configuration

Most of the configuration settings are either predefined according to the Load Optimal Defaults settings which are stored in the BIOS or are automatically detected and configured without requiring any actions. There are a few settings that you may need to change depending on your system configuration.

#### Entering the BIOS Setup Utility

The BIOS Setup Utility can only be operated from the keyboard and all commands are keyboard commands. The commands are available at the right side of each setup screen.

The BIOS Setup Utility does not require an operating system to run. After you power up the system, the BIOS message appears on the screen and the memory count begins. After the memory test, the message "Press DEL to run setup" will appear on the screen. If the message disappears before you respond, restart the system or press the "Reset" button. You may also restart the system by pressing the <Ctrl> <Alt> and <Del> keys simultaneously.

#### Legends

Keys	Function
Right / Left arrow	Move the highlight left or right to select a menu
Up / Down arrow	Move the highlight up or down between submenus or fields
<Enter>	Enter the highlighted submenu
+ (plus key)/F6	Scroll forward through the values or options of the highlighted field
- (minus key)/F5	Scroll backward through the values or options of the highlighted field
<F1>	Display general help
<F2>	Display previous values
<F12>	Popup Boot Device List
<F9>	Optimized defaults
<F10>	Save and Exit
<Esc>	Return to previous menu

#### Scroll Bar

When a scroll bar appears to the right of the setup screen, it indicates that there are more available fields not shown on the screen. Use the <K> and <M> keys to scroll through all the available fields.

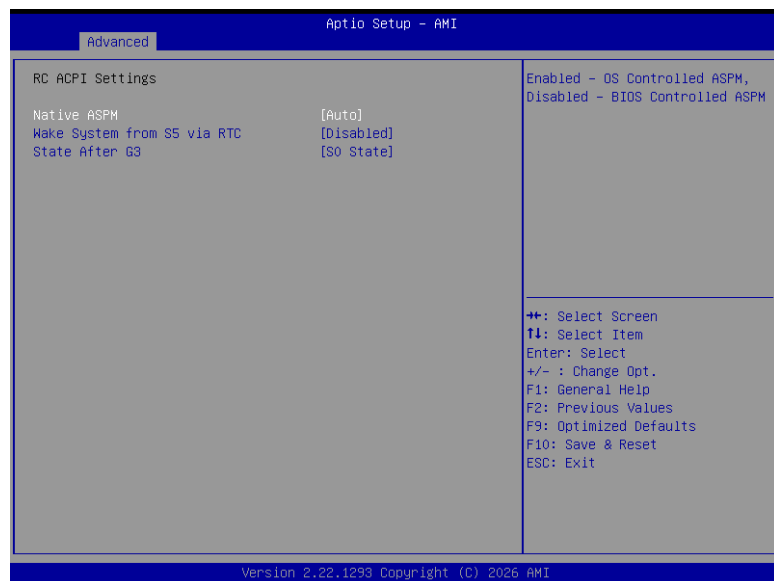
#### Submenu

When "►" appears on the left of a particular field, it indicates that a submenu which contains additional options are available for that field. To display the submenu, move the highlight to that field and press <Enter>.



▶ Advanced

RC ACPI Settings



**Wake system from S5 via RTC**

When Enabled, the system will automatically power up at a designated time every day. Once it's switched to [Enabled], please set up the time of day – hour, minute, and second – for the system to wake up.

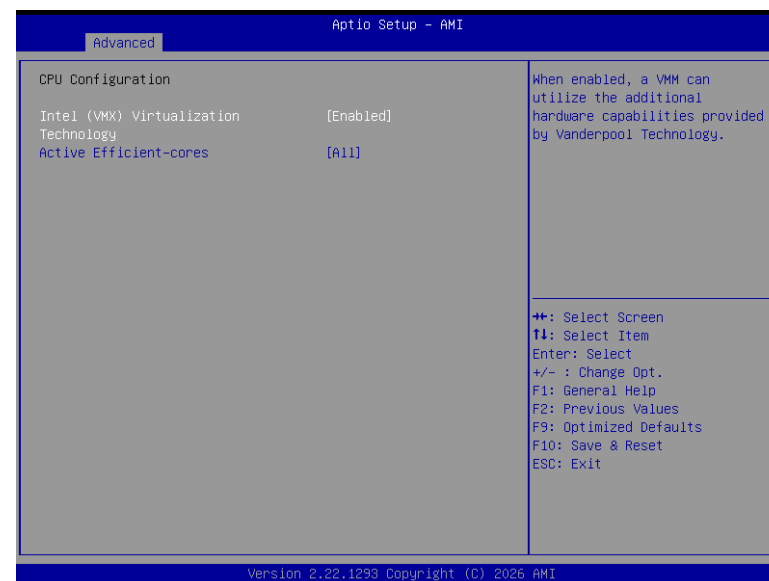
**State After G3**

Select between S0 State, and S5 State. This field is used to specify what state the system is set to return to when power is re-applied after a power failure (G3 state).

- **S0 State** The system automatically powers on after power failure.
- **S5 State** The system enter soft-off state after power failure. Power-on signal input is required to power up the system.

▶ Advanced

CPU Configuration



**Intel (VMX) Virtualization Technology**

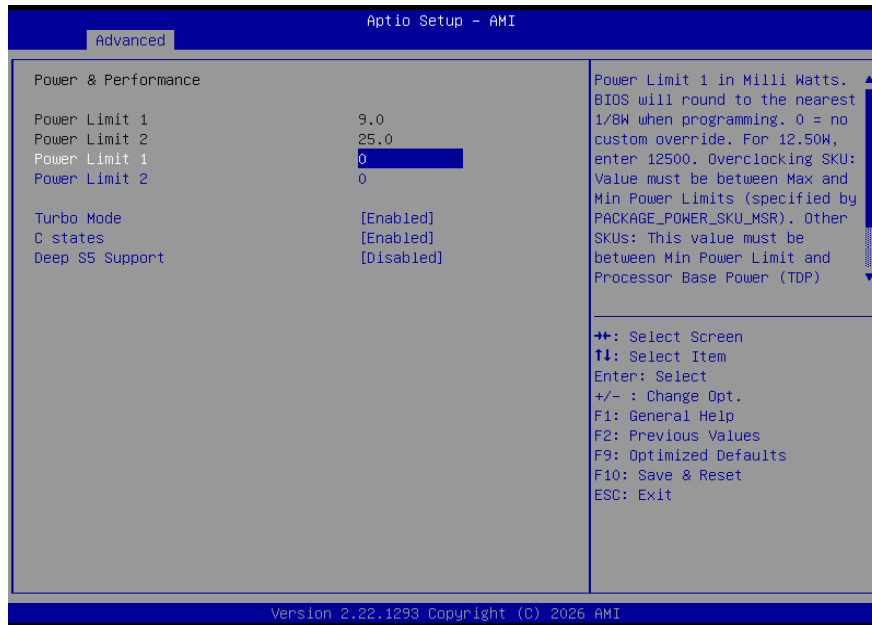
When this field is set to Enabled, the VMM can utilize the additional hardware capabilities provided by Vanderpool Technology.

**Active Efficient-cores : [All, 7,6,5,4,3,2,1]**

Number of E-cores to enable in each processor package.  
Note: Number of Cores and E-cores are looked at together. When both are {0,0}, the system will enable all cores.

▶ Advanced

Power & Performance



**Turbo Mode**

Enable or disable turbo mode of the processor. This field will only be displayed when EIST is enabled.

**C states**

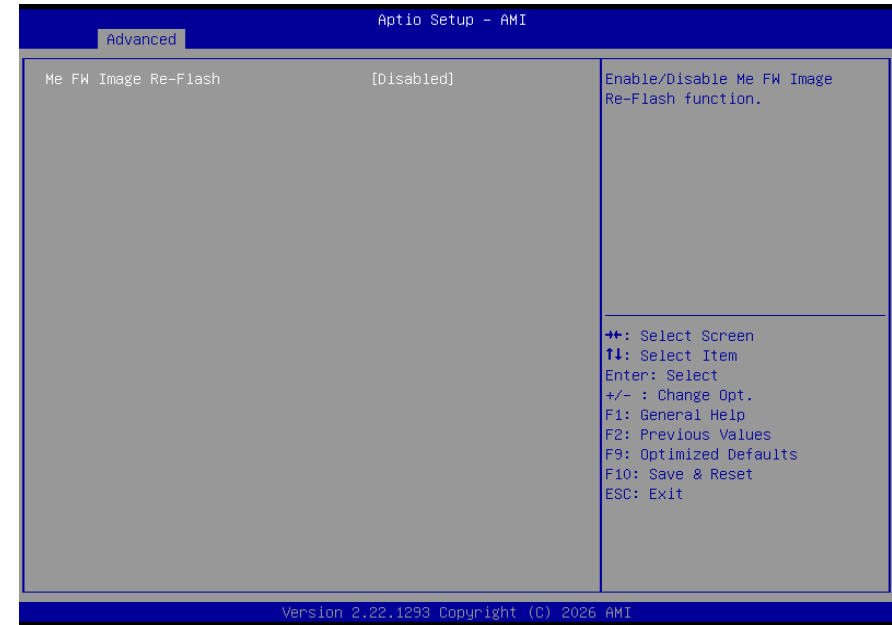
Enable or disable CPU Power Management. It allows CPU to enter "C states" when it's idle and nothing is executing.

**Deep S5 Support**

Deep S5 support settings.

▶ Advanced

PCH-FW Configuration



**ME FW Image Re-Flash**

Enable/Disable Me FW Image Re-Flash function.

▶ Advanced

Trusted Computing



**Security Device Support**

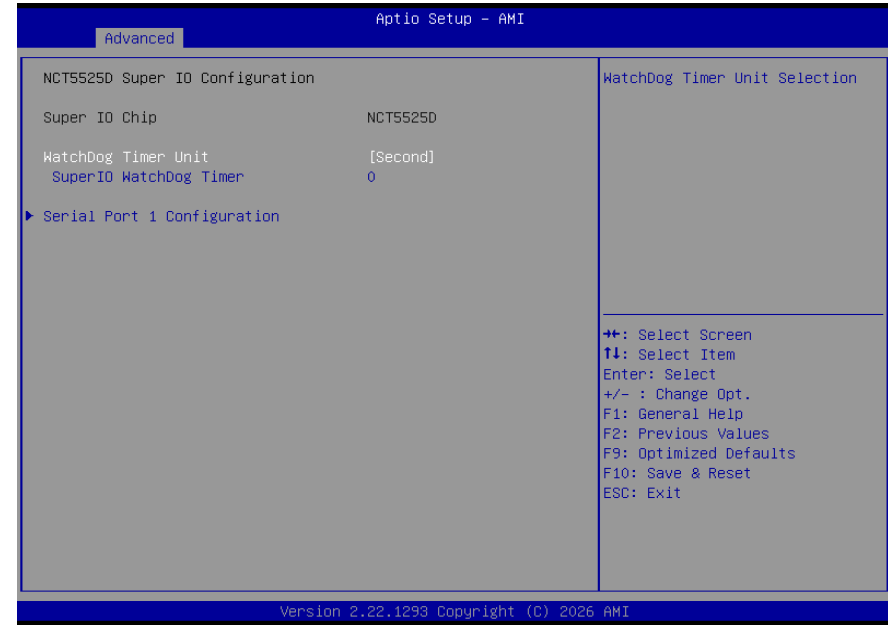
This field is used to enable or disable BIOS support for the security device such as an TPM 2.0 to achieve hardware-level security via cryptographic keys.

**Pending operation**

To clear the existing TPM encryption, select "TPM Clear" and restart the system. This field is not available when "Security Device Support" is disabled.

▶ Advanced

NCT5525D Super IO Configuration



**WatchDog Timer Unit**

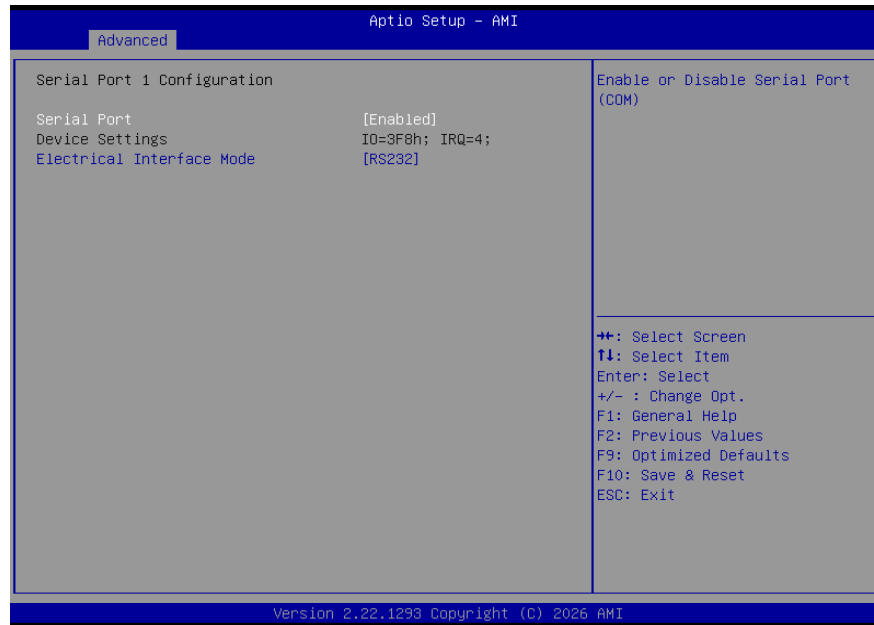
Select WatchDog Timer Unit — Second or Minute.

**SuperIO WatchDog Timer**

Set SuperIO WatchDog Timer Timeout value. The range is from 0 (disabled) to 255.

▶ Advanced

NCT5525D Super IO Configuration ▶ Serial Port 1 Configuration

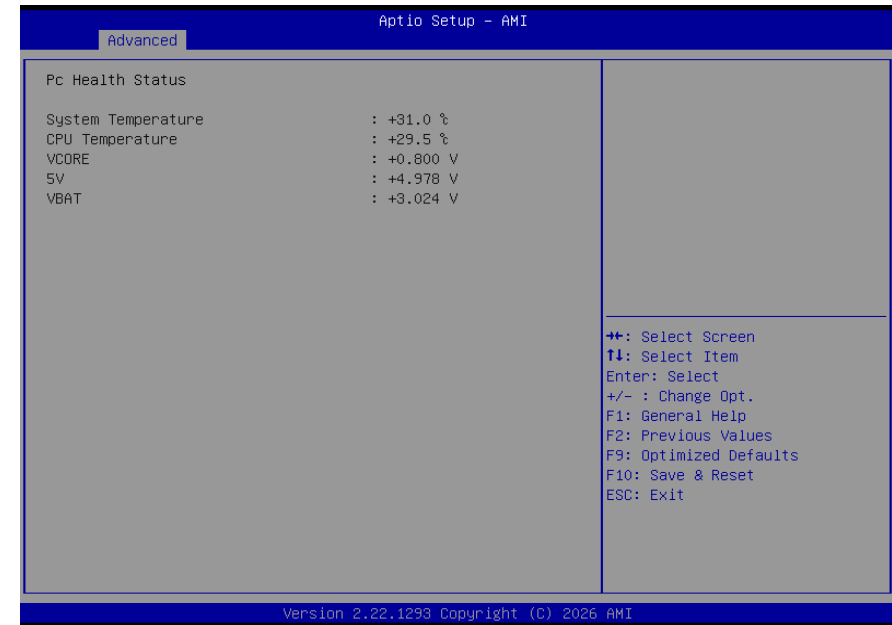


**Serial Port**

Enable or disable serial port.

▶ Advanced

Hardware Monitor



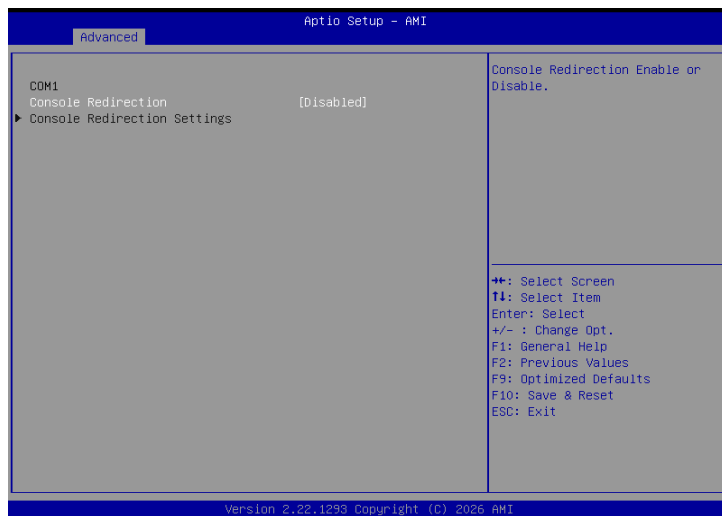
This section displays the system's health information, i.e. voltage readings, CPU and system temperatures, and fan speed readings

**Smart Fan Function**

Smart Fan Function Setting.

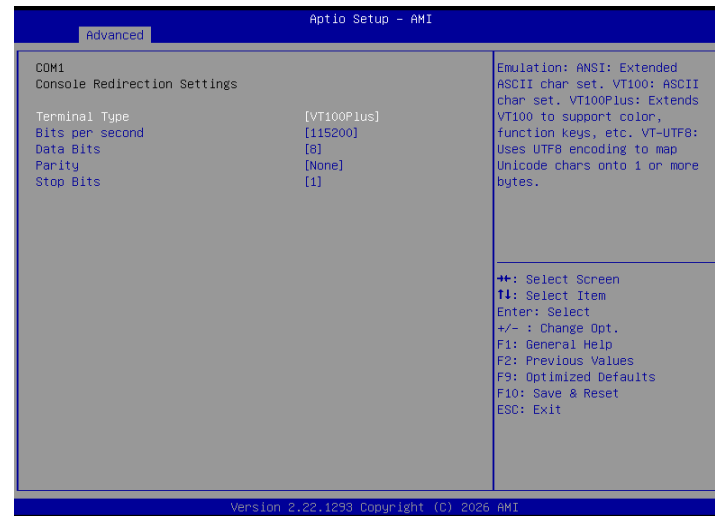
► Advanced

Serial Port Console Redirection



► Advanced

Serial Port Console Redirection ► Console Redirection Settings



Configure the serial settings of the current COM port.

**Terminal Type**

Select terminal type: VT100, VT100+, VT-UTF8 or ANSI.

**Bits per second**

Select serial port transmission speed: 9600, 19200, 38400, 57600 or 115200.

**Data Bits**

Select data bits: 7 bits or 8 bits.

**Parity**

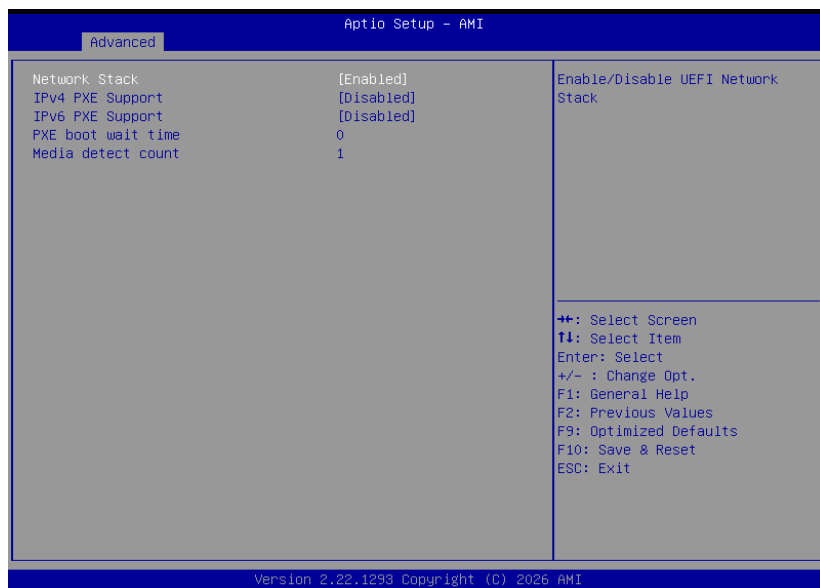
Select parity bits: None, Even, Odd, Mark or Space.

**Stop Bits**

Select stop bits: 1 bit or 2 bits.

► Advanced

## Network Stack Configuration



### Network Stack

Enable or disable UEFI network stack. The following fields will appear when this field is enabled.

### Ipv4 PXE Support

Enable or disable IPv4 PXE boot support. If disabled, IPv4 PXE boot support will not be available.

### Ipv6 PXE Support

Enable or disable IPv6 PXE boot support. If disabled, IPv6 PXE boot support will not be available.

### PXE boot wait time

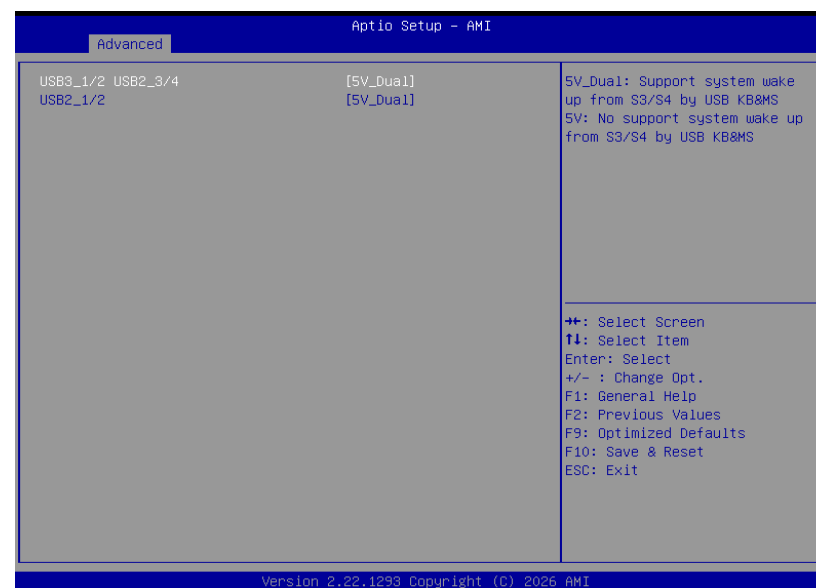
Set the wait time in seconds to press ESC key to abort the PXE boot. Use either +/- or numeric keys to set the value.

### Media detect count

Set the number of times the presence of media will be checked. Use either +/- or numeric keys to set the value.

► Advanced

## USB Power Control



### Server CA Configuration

**5\_Dual:** Support system wake up from S3/S4 by USB KB&MS

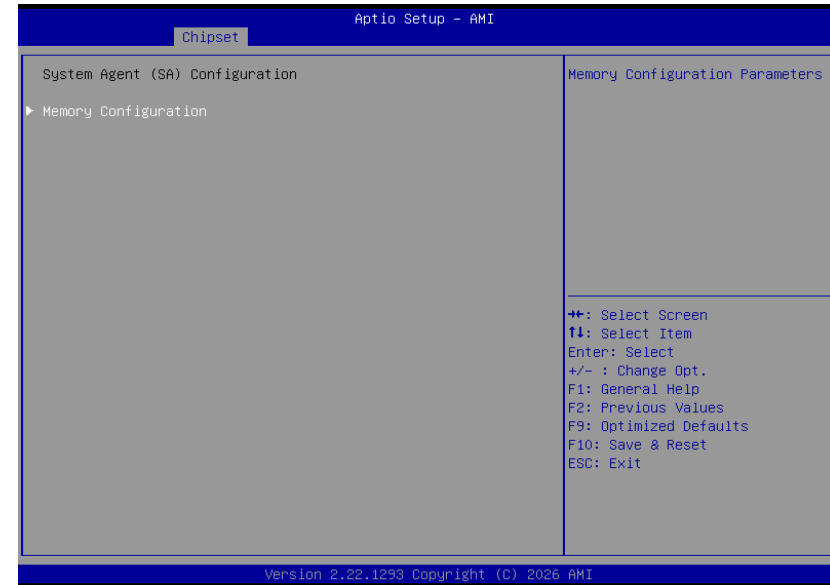
**5V:** No support system wake up from S3/S4 by USB KB&MS

► Chipset



► Chipset

System Agent (SA) Configuration



Please select a submenu and press Enter. The submenus are detailed in the following pages.

► Chipset

System Agent (SA) Configuration ► Memory Configuration

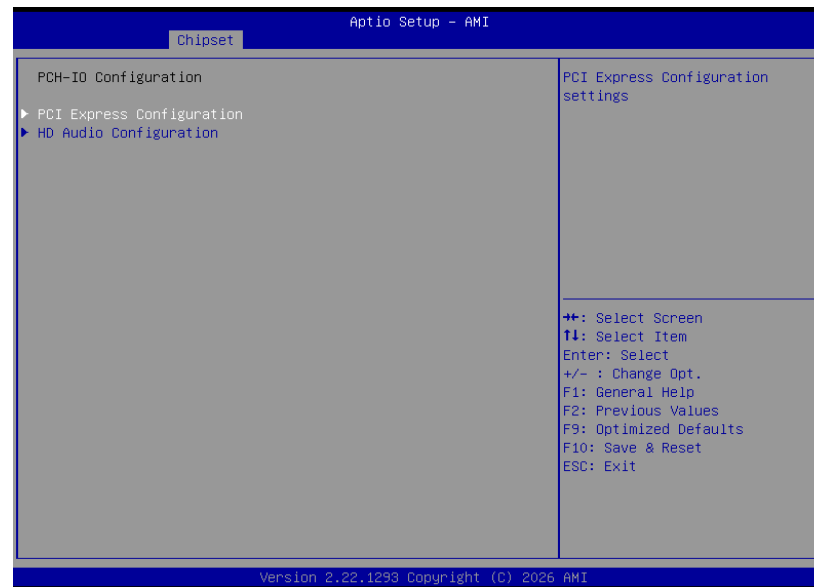


**In-Band ECC Support**

Enable/Disable In-Band ECC.  
Will be enabled if memory has symmetric configuration

► Chipset

PCH-IO Configuration



**PCI Express Configuration**

PCI Express Configuration Settings

**HD Audio Configuration**

HD Audio Subsystem Configuration Settings

► Chipset

PCH-IO Configuration ► PCI Express Configuration



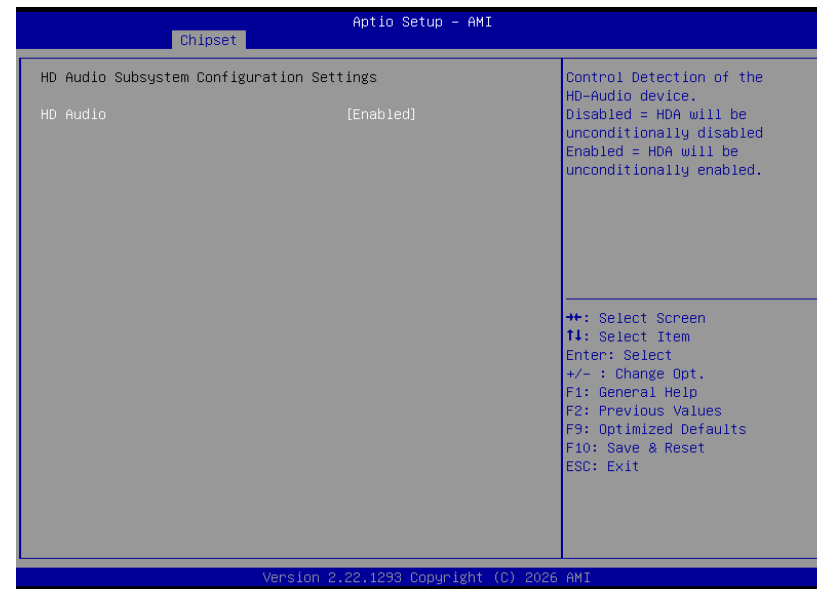
Select one of the PCI Express channels and press enter to configure the following settings.

**LAN 1, M.2-E**

Control the PCI Express Root Port.

► Chipset

PCH-IO Configuration ► HD Audio Configuration

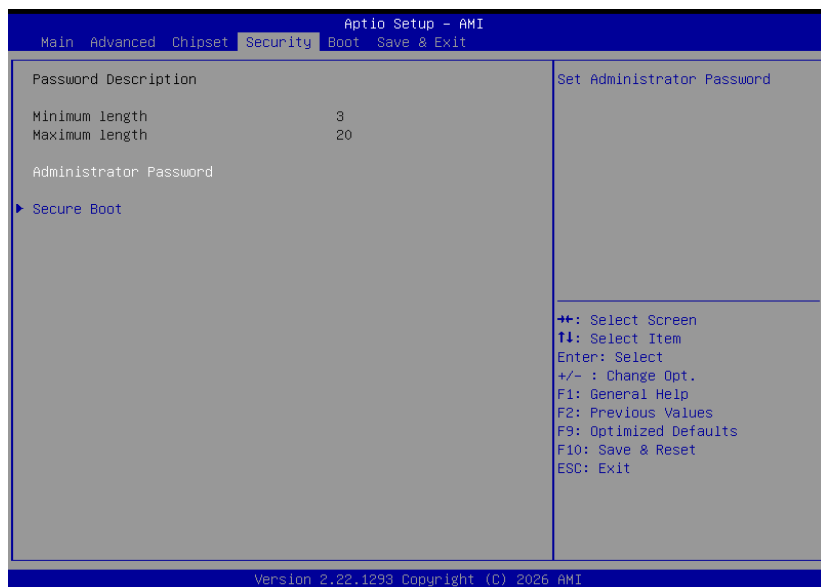


**HD Audio**

Control the detection of the HD Audio device.

- **Disabled** HDA will be unconditionally disabled.
- **Enabled** HDA will be unconditionally enabled.

► Security



**Administrator Password**

Set the administrator password. To clear the password, input nothing and press enter when a new password is asked. Administrator Password will be required when entering the BIOS.

► Security

Secure Boot



**Secure Boot**

The Secure Boot store a database of certificates in the firmware and only allows the OSeS with authorized signatures to boot on the system. To activate Secure Boot, please make sure that "Secure Boot" is "[Enabled]", Platform Key (PK) is enrolled, "System Mode" is "User", and CSM is disabled. After enabling/disabling Secure Boot, please save the configuration and restart the system. When configured and activated correctly, the Secure Boot status will be "Active".

**Secure Boot Mode**

Select the secure boot mode – Standard or Custom. When set to Custom, the following fields will be configurable for the user to manually modify the key database.

**Restore Factory Keys**

Force system to User Mode. Load OEM-defined factory defaults of keys and databases onto the Secure Boot. Press Enter and a prompt will show up for you to confirm.

**Reset To Setup Mode**

Clear the database from the NVRAM, including all the keys and signatures installed in the Key Management menu. Press Enter and a prompt will show up for you to confirm.

**Key Management**

Enables expert users to modify Secure Boot Policy variables without full authentication.

► Boot



**Setup Prompt Timeout**

Set the number of seconds to wait for the setup activation key. 65535 (0xFFFF) denotes indefinite waiting.

**Bootup NumLock State**

Select the keyboard NumLock state: On or Off.

**Quiet Boot**

This section is used to enable or disable quiet boot option.

**Boot Option Priorities**

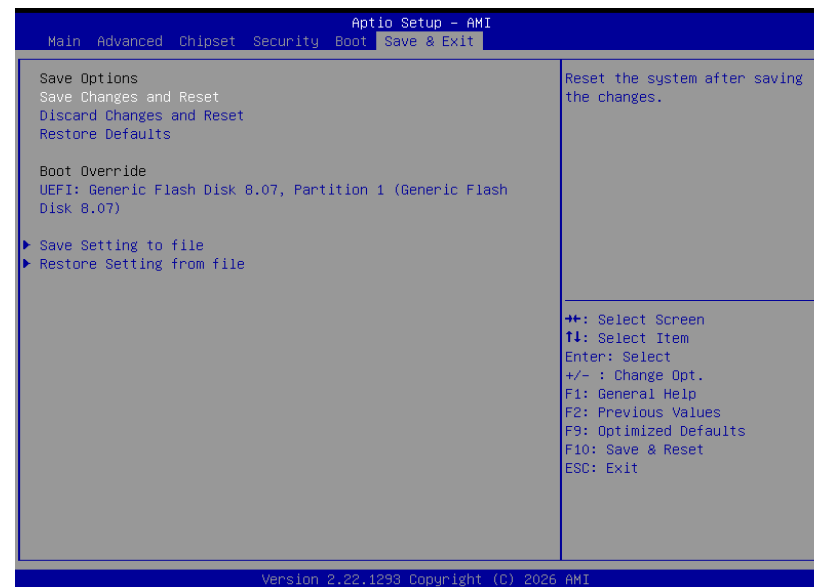
Rearrange the system boot order of available boot devices.



**Note:**

If “Quiet Boot” is enabled, “BGRT Logo” will show up for configuration.

► Save & Exit



**Save Changes and Reset**

To save the changes, select this field and then press <Enter>. A dialog box will appear. Select Yes to reset the system after saving all changes made.

**Discard Changes and Reset**

To discard the changes, select this field and then press <Enter>. A dialog box will appear. Select Yes to reset the system setup without saving any changes.

**Restore Defaults**

To restore and load the optimized default values, select this field and then press <Enter>. A dialog box will appear. Select Yes to restore the default values of all the setup options.

**Boot Override**

Move the cursor to an available boot device and press Enter, and then the system will immediately boot from the selected boot device. The Boot Override function will only be effective for the current boot. The “Boot Option Priorities” configured in the Boot menu will not be changed.

- **Save Setting to file** Select this option to save BIOS configuration settings to a USB flash device.
- **Restore Setting from file** This field will appear only when a USB flash device is detected. Select this field to restore setting from the USB flash device.

## ► Updating the BIOS

To update the BIOS, you will need the new BIOS file and a flash utility. Please contact technical support or your sales representative for the files and specific instructions about how to update BIOS with the flash utility.

## ► Notice: BIOS SPI ROM

1. The Intel® Management Engine has already been integrated into this system board. Due to the safety concerns, the BIOS (SPI ROM) chip cannot be removed from this system board and used on another system board of the same model.
2. The BIOS (SPI ROM) on this system board must be the original equipment from the factory and cannot be used to replace one which has been utilized on other system boards.
3. If you do not follow the methods above, the Intel® Management Engine will not be updated and will cease to be effective.



**Note:**

- a. You can take advantage of flash tools to update the default configuration of the BIOS (SPI ROM) to the latest version anytime.
- b. When the BIOS IC needs to be replaced, you have to populate it properly onto the system board after the EEPROM programmer has been burned and follow the technical person's instructions to confirm that the MAC address should be burned or not.

## Appendix A- Mating Connectors

### ► The Mating Connectors List

Please refer to the following list of the mating connectors.

Function	Connector	Connector information	Rate output
USB2.0	J1	JST, BM08B-SRSS-TB1(LF)(SN), 1*8P, 1.0mm, BOX HEADER	5V/1A
I2C	J6	JST, BM05B-SRSS-TB1(LF)(SN), 1*5P, 1.0mm, BOX HEADER	3V/1A
DIO	J5	JST, BM10B-SRSS-TB1(LF)(SN), 1*10P, 1.0mm, BOX HEADER	5V/1A
COM1	TSJ1	PINREX, 710-93-095WR00B, 1*9P, 1.0mm, BOX HEADER	NA
FAN	J4	E-CALL, 0110-3221030, 1*3P, 1.25mm, WAFER	NA
Battery	J7	PINREX, 712-74-025WR0, 1*2P, 1.25mm, BOX HEADER	NA